

Parameter	Rating	Units
Blocking Voltage	60	V _P
Load Current	700	mA _{DC}
On-Resistance (max)	0.55	Ω
LED Current to operate	2	mA

Features

- Designed for use in security systems complying with EN50130-4
- Only 2mA of LED current required to operate
- Small 4-Pin SOP Package
- TTL/CMOS Compatible input
- 100% Solid State
- High Reliability
- Arc-Free With No Snubbing Circuits
- 1500V_{rms} Input/Output Isolation
- No EMI/RFI Generation
- Immune to radiated EM fields
- SMD Pick & Place, Wave Solderable
- Tape & Reel Version Available

Applications

- Security
 - Passive Infrared Detectors (PIR)
 - Data Signalling
 - Sensor Circuitry
- Instrumentation
 - Multiplexers
 - Data Acquisition
 - Electronic Switching
 - I/O Subsystems
- Meters (Watt-Hour, Water, Gas)
- Medical Equipment—Patient/Equipment Isolation
- Aerospace
- Industrial Controls

Description

The CPC1002N is a miniature, normally open (1-Form-A) DC solid state relay in a 4-Pin SOP package that employs optically coupled MOSFET technology to provide 1500V_{rms} of input to output isolation. The super-efficient MOSFET switches and photovoltaic die use IXYS Integrated Circuits Division's patented OptoMOS architecture. The optically coupled output is controlled by the input's highly efficient GaAlAs infrared LED.

The CPC1002N uses IXYS Integrated Circuits Division's state of the art double-molded vertical construction packaging to produce one of the world's smallest relays. The CPC1002N offers board space savings of at least 20% over the competitor's larger 4-Pin SOP relay.

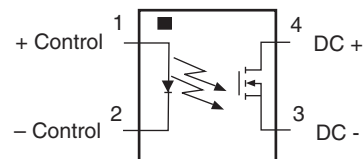
Approvals

- UL Recognized Component: File E76270
- CSA Certified Component: Certificate 1175739
- EN/IEC 60950-1 Certified Component:
TUV Certificate B 09 07 49410 004

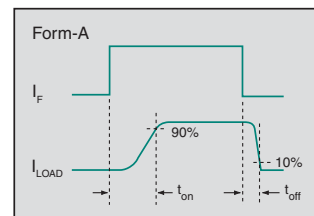
Ordering Information

Part #	Description
CPC1002N	4-Pin SOP (100/tube)
CPC1002NTR	4-Pin SOP (2000/reel)

Pin Configuration



Switching Characteristics of Normally Open Devices



Absolute Maximum Ratings @ 25°C

Parameter	Ratings	Units
Blocking Voltage	60	V _P
Reverse Input Voltage	5	V
Input Control Current	50	mA
Peak (10ms)	1	A
Input Power Dissipation	70	mW
Total Power Dissipation ¹	400	mW
Isolation Voltage Input to Output	1500	V _{rms}
Operational Temperature	-40 to +85	°C
Storage Temperature	-40 to +125	°C

¹ Derate linearly 3.33 mW / °C

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

Electrical Characteristics @ 25°C

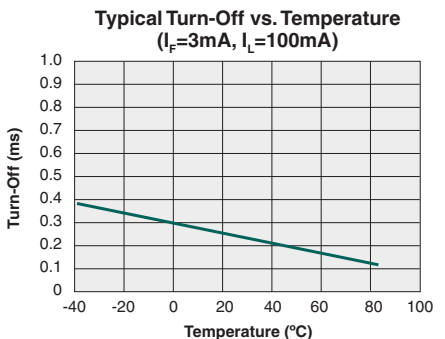
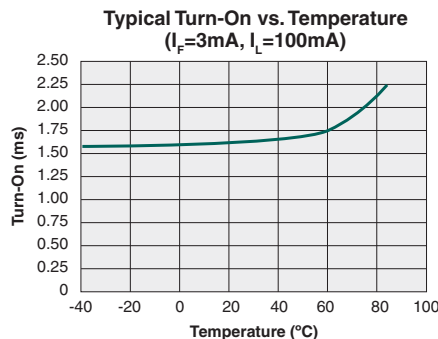
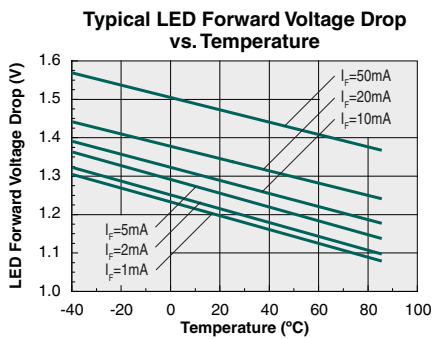
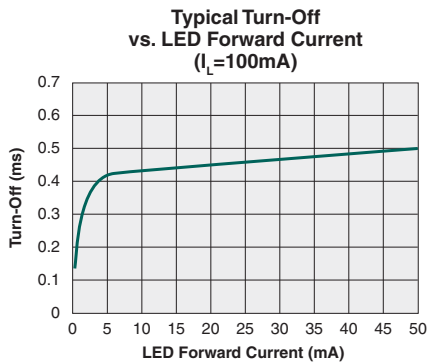
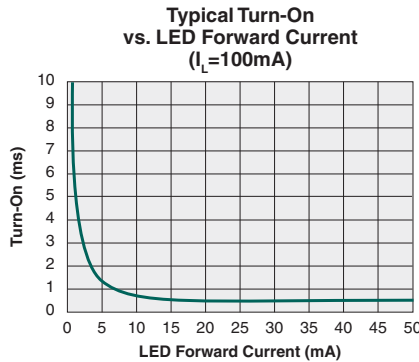
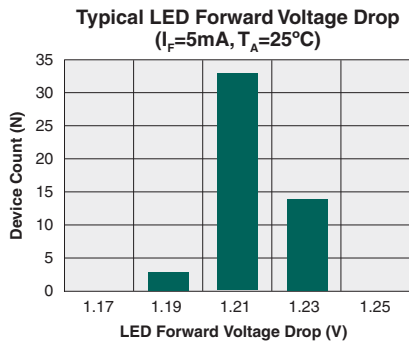
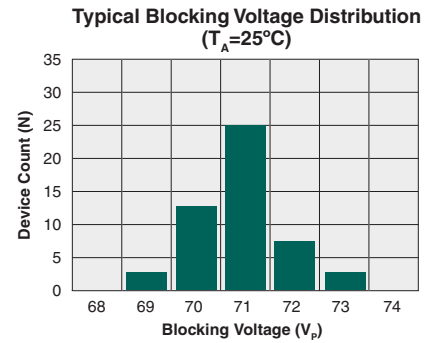
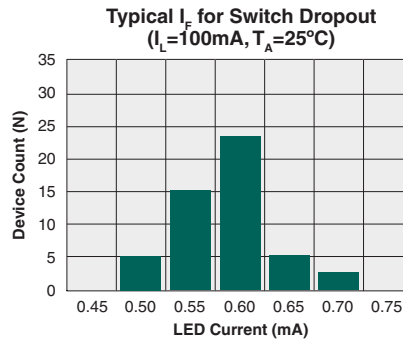
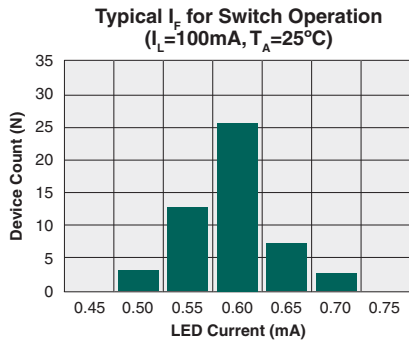
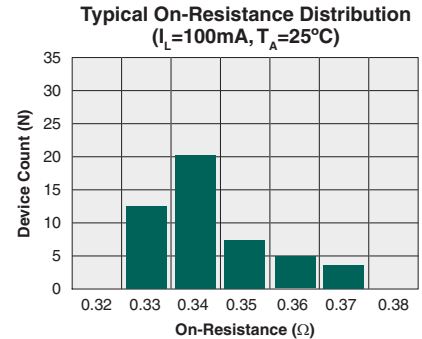
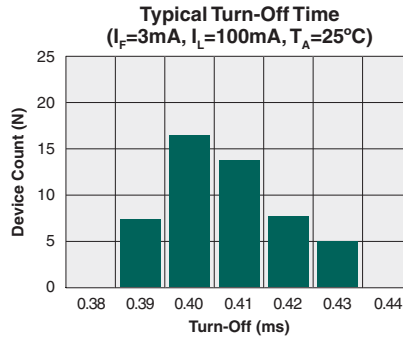
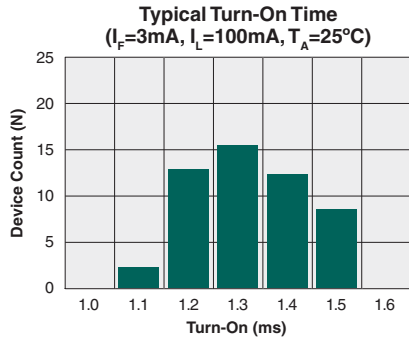
Parameter	Conditions	Symbol	Min	Typ	Max	Units
Output Characteristics						
Load Current, Continuous ¹	I _F =2mA	I _L	-	-	700	mA _{DC}
Peak Load Current	t=10ms	I _{LPK}	-	-	1	A _P
On-Resistance ²	I _L =100mA	R _{ON}	-	0.35	0.55	Ω
Off-State Leakage Current	V _L =60V _P	I _{LEAK}	-	-	1	μA
Switching Speeds						
Turn-On	I _F =3mA, V _L =10V	t _{on}	-	1.3	5	ms
Turn-Off		t _{off}	-	0.41	2	
Output Capacitance	V _L =50V; f=1MHz	C _{OUT}	-	25	-	pF
Input Characteristics						
Input Control Current to Activate ³	I _L =100mA	I _F	-	0.55	2	mA
Input Control Current to Deactivate	-	I _F	0.3	-	-	mA
Input Voltage Drop	I _F =5mA	V _F	0.9	1.2	1.4	V
Reverse Input Current	V _R =5V	I _R	-	-	10	μA
Common Characteristics						
Capacitance Input to Output	-	C _{I/O}	-	1	-	pF

¹ Load current derates linearly from 700mA @ 25°C to 420mA @ 80°C.

² Measurement taken within 1 second of on-time.

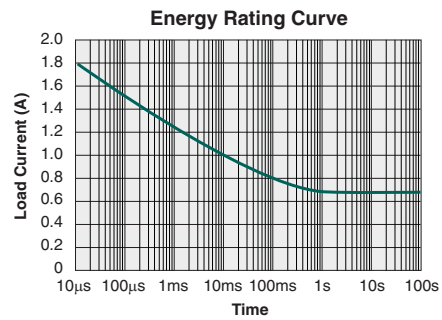
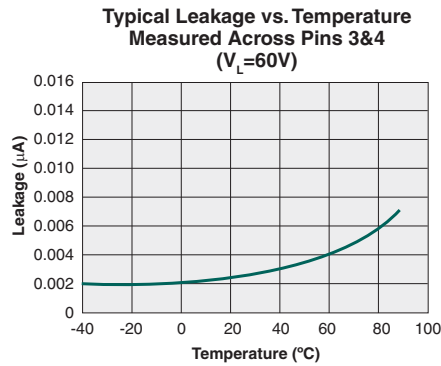
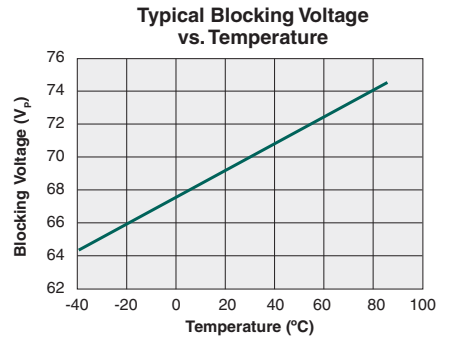
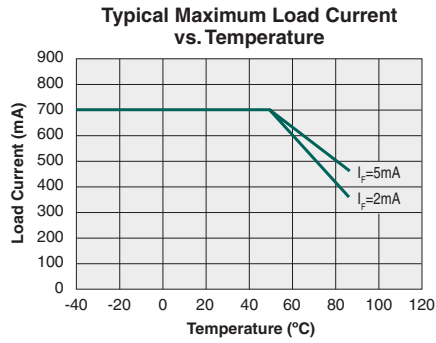
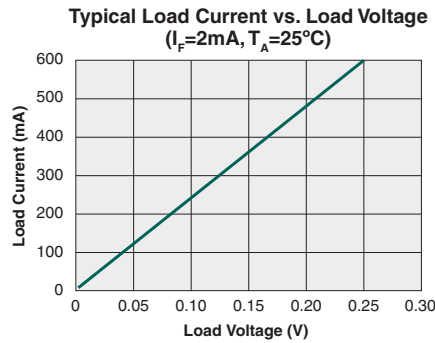
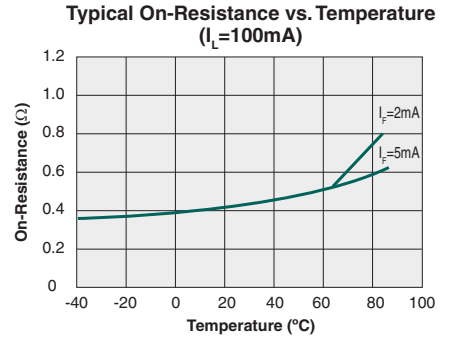
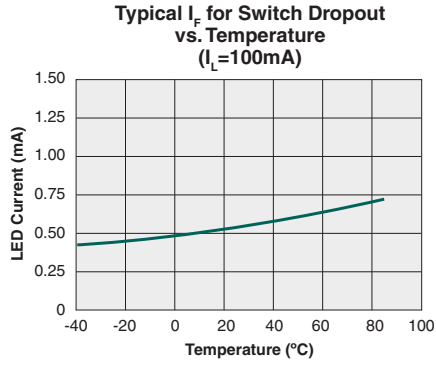
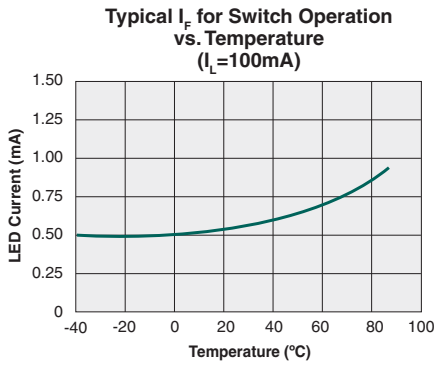
³ For applications requiring high temperature operation (greater than 60°C) a LED drive current of 3mA is recommended.

PERFORMANCE DATA *



*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

PERFORMANCE DATA *



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Manufacturing Information

Moisture Sensitivity



All plastic encapsulated semiconductor packages are susceptible to moisture ingress. IXYS Integrated Circuits Division classified all of its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a **Moisture Sensitivity Level (MSL) rating** as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Rating
CPC1002N	MSL 3

ESD Sensitivity



This product is **ESD Sensitive**, and should be handled according to the industry standard **JESD-625**.

Reflow Profile

This product has a maximum body temperature and time rating as shown below. All other guidelines of **J-STD-020** must be observed.

Device	Maximum Temperature x Time
CPC1002N	260°C for 30 seconds

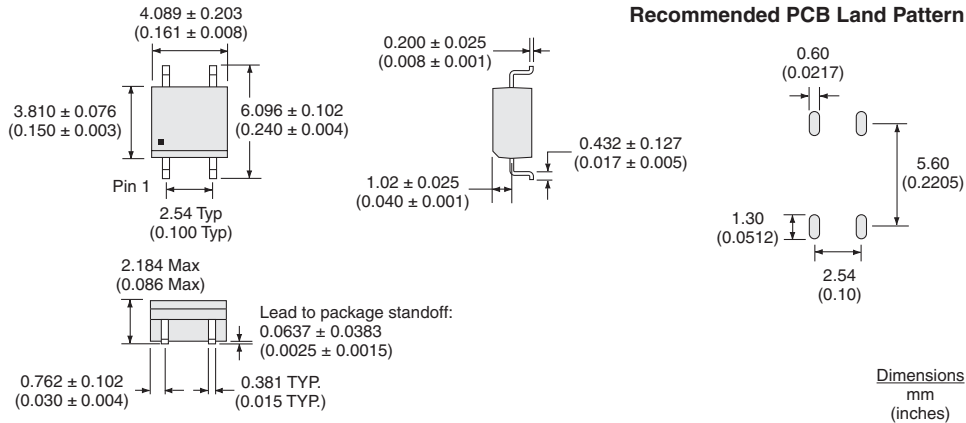
Board Wash

IXYS Integrated Circuits Division recommends the use of no-clean flux formulations. However, board washing to remove flux residue is acceptable. Since IXYS Integrated Circuits Division employs the use of silicone coating as an optical waveguide in many of its optically isolated products, the use of a short drying bake could be necessary if a wash is used after solder reflow processes. Chlorine- or Fluorine-based solvents or fluxes should not be used. Cleaning methods that employ ultrasonic energy should not be used.

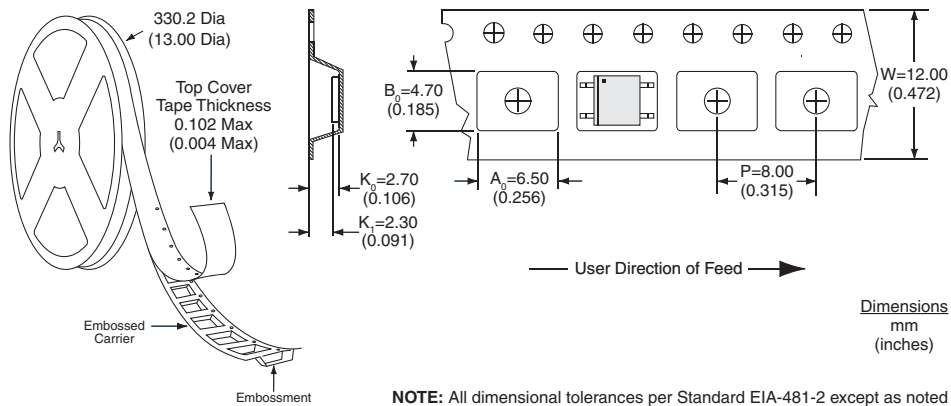


MECHANICAL DIMENSIONS

CPC1002N



CPC1002NTR Tape & Reel



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